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CND0313A

Infrared Optical Module (IrDA)

Infrared data link for cellular phones, peripheral devices

Features

- Compliant with IrDA Ver.1.4
- Light emitting function for remote controller
- Corresponding low I/O (interface) voltage: 1.5 V
- Corresponding reflow solder (260°C)
- Ultra-small side view package (1.45 mm \times 6.7 mm \times 2.15 mm)

Туре

• GaAlAs LED + IC + PIN Photodiode

Parameter	Symbol	Rating	Unit	
Operating supply voltage	V _{CC}	-0.5 to +3.8	V	
LED operating supply voltage	V _{LEDA}	-0.5 to +7.0	V	
Input/output supply voltage	V _{IO}	-0.5 to +3.8	V	
TX Input voltage	V _{TX}	-0.5 to +3.8	V	
Shutdown input voltage	V _{SD}	-0.5 to +3.8	V	
LED operating supply current *	I _{LEDA}	300	mA	
Operating ambient temperature	T _{opr}	-20 to +70	°C	
Storage temperature	T _{stg}	-30 to +85	°C	

Absolute Maximum Ratings $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) *: tw $\leq 90 \ \mu$ s, Duty $\leq 25 \%$

Operatong Condition

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating supply voltage	V _{CC}		2.5	2.85	3.3	V
LED operating supply voltage	V _{LEDA}		3.0		4.5	V
Input/output supply voltage	V _{IO}		1.5	1.85	V _{CC}	V

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Shut down supply current *Fig. 1	I _{CCSD}	$\begin{split} V_{TXD} &= 0.5 \text{ V}, \\ V_{IO} &\geq V_{SD} \geq V_{IO} - 0.5 \text{ V} \text{ (SD = High)} \end{split}$		0.01	0.2	μΑ
High level supply current (Idle) *Fig. 1	T	(FIR mode / RC mode) $E_I = 0 \text{ mW/cm}^2$, $V_{TXD} = 0.5 \text{ V}$, $V_{SD} \le 0.5 \text{ V}$		580	800	- μΑ
rightevel supply current (fulle)	I _{CCH}	(SIR mode) E ₁ = 0 mW/cm ² , V _{TXD} = 0.5 V, V _{SD} \leq 0.5 V		300	400	
•T ¹ -1	-	(FIR mode / RC mode) $E_I = 9.0 \text{ mW/cm}^2$, $V_{TXD} = 0.5 \text{ V}$, $V_{SD} \le 0.5 \text{ V}$		980	1270	μΑ
Low level supply current (Active) *Fig. 1	I _{CCL}	(SIR mode) E _I = 9.0 mW/cm ² , V _{TXD} = 0.5 V, V _{SD} \leq 0.5 V		350	460	
TX High level	T	$ (FIR mode / RC mode) \\ V_{IO} \ge V_{TXD} \ge V_{IO} - 0.5 V (TXD = High) \\ E_I = 0 mW/cm^2, V_{SD} \le 0.5 V $		1 200	1 560	μA
supply current (Active) *Fig. 1	I _{CCTXH}	(SIR mode) $V_{IO} \ge V_{TXD} \ge V_{IO} - 0.5 \text{ V} (TXD = \text{High})$ $E_I = 0 \text{ mW/cm}^2, V_{SD} \le 0.5 \text{ V}$		600	780	
High level input/output supply current (Idle) * ^{Fig. 1}	I _{IOH}	(FIR mode / RC mode) $E_I = 0 \text{ mW/cm}^2$, $V_{TXD} = 0.5 \text{ V}$, $V_{SD} \le 0.5 \text{ V}$	0	0	5	μA
		(SIR mode) $E_I = 0 \text{ mW/cm}^2, V_{TXD} = 0.5 \text{ V}, V_{SD} \le 0.5 \text{ V}$	0	0	5	
Low level input/output supply current (Active) *Fig. 1	I _{IOL}	(FIR mode / RC mode) $E_I = 9.0 \text{ mW/cm}^2$, $V_{TXD} = 0.5 \text{ V}$, $V_{SD} \le 0.5 \text{ V}$		360	470	μA
		(SIR mode) E _I = 9.0 mW/cm ² , V _{TXD} = 0.5 V, V _{SD} \leq 0.5 V		100	130	
TX High level	I _{IOTXH}	(FIR mode / RC mode) $V_{IO} \ge V_{TXD} \ge V_{IO} - 0.5 V (TXD = High)$ $E_I = 0 \text{ mW/cm}^2, V_{SD} \le 0.5 V$		80	120	^
input/output supply current (Active) *Fig. 1	HUTAH	$ \begin{array}{l} (SIR \mbox{ mode}) \\ V_{IO} \geq V_{TXD} \geq V_{IO} - 0.5 \mbox{ V} (TXD = High) \\ E_I = 0 \mbox{ mW/cm}^2, V_{SD} \leq 0.5 \mbox{ V} \end{array} $		40	60	μA
SD High level input voltage	V _{IHSD}		$V_{IO}\!-\!0.5$		V_{IO} + 0.3	V
SD Low level input voltage	V _{ILSD}		0 - 0.3		0.5	V
Maximum reception distance *Fig. 1, 4	L _{max}	$\begin{split} V_{SD} &\leq 0.5 \text{ V} \\ \theta_T &= 0^\circ \pm 15^\circ \\ \text{LEDie} &= 3.6 \text{ mW/sr} \text{ (SIR mode)} \\ \text{LEDie} &= 9 \text{ mW/sr} \text{ (FIR mode)} \end{split}$	20	_	_	cm
RC maximum reception distance *Fig. 1, 10	L _{maxR}	$\begin{split} V_{LEDA} &= 3.0 \text{ V}, V_{SD} \leq 0.5 \text{ V} \\ \theta_T &= 0^\circ \pm 15^\circ, \text{ Carrier duty} = 1/3 \\ 940 \text{ nm Radiant intensity ratio} &= 57.5 \% \\ \text{RC Receiver sensitivity} \ ^{*2} &= 0.05 \ \mu\text{W/cm}^2 \end{split}$	5.14	_	_	m
Data Rates *1			0.0096		4.0	Mbps

Electrical-Optical Characteristics $V_{LEDA} = 3.0 \text{ V}$ to 4.5 V, $V_{CC} = 2.85 \text{ V}$, $V_{IO} = 1.85 \text{ V}$, $T_a = 25^{\circ}\text{C}\pm3^{\circ}\text{C}$

Note) *1: Fully Compliant to IrDA1.4 Low Power Specification from 9.6 kbps to 115.2 kbps, 4 Mbps.

*2: Definition of RC receiver sensitivity

RC receiver sensitivity is adjusted so that RC transfer distance is 4 m at transmitter LED radiant intensity= 8 mW/sr,

peak wave length = 940 nm and duty = 50 %, where irradiance is 0.05 $\mu W/cm^2.$

Electrical-Optical Characteristics (continued) V _{LEDA}	$= 3.0 \text{ V} \text{ to } 4.5 \text{ V}, \text{ V}_{\text{CC}} = 2.85 \text{ V}, \text{ V}_{\text{IO}} = 1.85 \text{ V}, \text{ T}_{\text{a}} = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$
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Parame	eter	Symbol	Conditions	Min	Тур	Max	Unit
Transmitter			·				
			(FIR mode / RC mode) $V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V}, \text{Duty}1/4$	880	890	900	
Peak emission wavelen	gtn ^{- e}	λ_{P}	(SIR mode) $V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V}, \text{Duty3/16}$	875	885	900	nm
LED operating supply current *Fig. 1		Ţ	(FIR Mode/RC Mode) $V_{LEDA} = 4.3 \text{ V}, \text{VSD} \le 0.5 \text{ V}, \text{Duty1/4}$	165	207	248	
			(FIR Mode/RC Mode) $V_{LEDA} = 3.0 \text{ V}, \text{VSD} \le 0.5 \text{ V}, \text{Duty1/4}$	160	200	240	
LLD operating suppry c	unent	I _{LEDA}	(SIR Mode) $V_{LEDA} = 4.3 \text{ V}, V_{SD} \le 0.5 \text{ V}, \text{Duty3/16}$	70	91	109	mA
			(SIR Mode) V _{LEDA} = 3.0 V, V _{SD} \leq 0.5 V, Duty3/16	69	90	108	
$\theta_{\rm T} = 0^{*{\rm Fig. 1, 2}}$ Center radiant intensity *3 $\theta_{\rm T} = 0^{*{\rm Fig. 1, 2}}$	Ie	(FIR Mode/RC Mode) $V_{LEDA} = 3.0 \text{ V}, \text{VSD} \le 0.5 \text{ V}, \text{Duty1/4}$	30	70	105	- mW/sr	
		(SIR Mode) $V_{LEDA} = 3.0 \text{ V}, V_{SD} \le 0.5 \text{ V}, \text{Duty3/16}$	15	35	52		
	T	(FIR Mode/RC Mode) $V_{LEDA} = 3.0 \text{ V}, V_{SD} \le 0.5 \text{ V}, \text{Duty}1/4$	23	38	57		
$\theta_{\rm T} = \pm 15^{*{\rm Fig.1,2,10}}$		I _{e15}	(SIR Mode) $V_{LEDA} = 3.0 \text{ V}, V_{SD} \le 0.5 \text{ V}, \text{Duty3/16}$	7	19	28	- mW/sr
TX high level input vol	tage	V _{IH(TX)}		$V_{IO} - 0.5$		V _{CC} +0.3	V
TX low level input volta	age	V _{IL(TX)}		0 -0.3		0.5	V
TX pulse width (SIR) *I	Fig. 1, 8	t _{WT(SIR)}	Bit Rate = 115.2 kbps, $V_T = 1/2 \times V_{IO}$		1.6		μs
TX pulse width (FIR) *I	Fig. 1, 8	t _{WT(FIR)}	Bit Rate = 4.0 Mbps, $V_T = 1/2 \times V_{IO}$		125		ns
Optical pulse width (FII	R1) *Fig. 1, 3	t _{WO(FIR1)}	$\begin{split} V_{SD} &\leq 0.5 \text{ V}, \text{TXD } t_r / t_f \leq 20 \text{ ns}, \\ t_W &= 125 \text{ ns} \pm 1 \text{ ns}, \text{(Single pulse)} \end{split}$	115	125	135	ns
Optical pulse width (FII	R2) * ^{Fig. 1, 3}	t _{WO(FIR2)}	$\begin{split} V_{SD} &\leq 0.5 \text{ V}, \text{TXD } t_{r} / t_{f} \leq 20 \text{ ns}, \\ t_{W} &= 250 \text{ ns} \pm 1 \text{ ns}, (\text{Double pulse}) \end{split}$	240	250	260	ns
TX half-angle		θ_{T}		±15			0
Rise time *Fig. 1, 3		t _r	$R_L = 50 \Omega$			40	ns
Fall time *Fig. 1, 3		t _f	$R_L = 50 \Omega$			40	ns
TX wake up time *Fig. 5		t _{TWU}		200		1 000	μs
Intensity delay time *Fig	. 1, 3	I _{DT}				200	ns
Maximum pulse width		t _{WLEDmax}	$TXD = Low \rightarrow High$	20	50	100	μs
Overshoot		Os		_		25	%

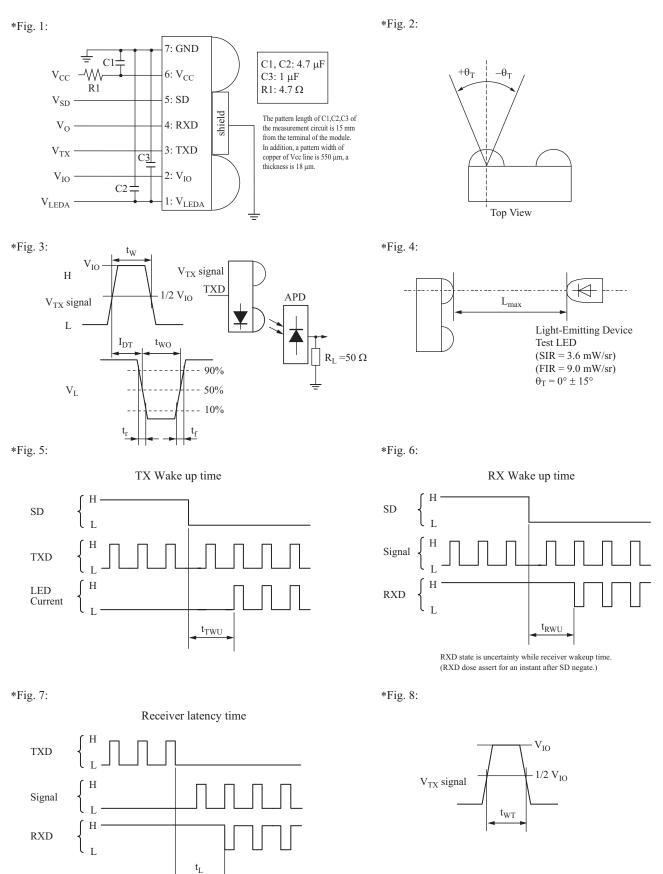
Note) *3: Eye-Safety IEC60825-1 Class1 Eye safe

Electrical-Optical Characteristics (continued) $V_{LEDA} = 3.0 \text{ V to } 4.5 \text{ V}, V_{CC} = 2.85 \text{ V}, V_{IO} = 1.85 \text{ V}, T_a = 25^{\circ}\text{C}\pm3^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Receiver	·	·				
*Fig 1	E _{I min1}	(SIR mode) Bit Rate = 115.2 kbps, $V_{SD} \le 0.5 V$, $\theta_T = 0^\circ \pm 15^\circ$			9.0	W/om?
Minimum input irradiance *Fig. 1	E _{I min2}	(FIR Mode) Bit Rate = 4.0 Mbps, $V_{SD} \le 0.5 V$, $\theta_T = 0^\circ \pm 15^\circ$	_		22.5	- μW/cm ²
Maximum input irradiance *Fig. 1	E _{I mix}	$V_{SD} \le 0.5 \text{ V}, \theta_T = 0^\circ \pm 15^\circ$	500			mW/cm ²
RX high level output voltage *Fig. 1	V _{OH(RX)}	Non signal condition $E_I = 0$ $I_{OH} = -200 \ \mu\text{A}, V_{SD} \le 0.5 \ \text{V}$	V _{IO} -0.3		V _{IO}	v
RX low level output voltage *Fig. 1	V _{OL(RX)}	$I_{OL} = 1.8 \text{ mA}, V_{SD} \le 0.5 \text{ V}$	0		0.5	V
RX half angle	θ_{R}		±15			0
Output pulse width (SIR) *Fig. 1, 9	t _{WR(SIR)}	$V_{SD} \le 0.5 \text{ V}, C_L = 15 \text{ pF},$ 9.6 kbps to 115.2 kbps	1.0		4.0	μs
Output pulse width (FIR1) *Fig. 1, 9	t _{WR(FIR1)}	$\begin{split} V_{SD} &\leq 0.5 \text{ V}, C_L = 15 \text{ pF}, \\ 4 \text{ Mbps, } t_W &= 125 \text{ ns} \pm 10 \text{ ns} \\ \text{(Single pulse)} \end{split}$	85		165	ns
Output pulse width (FIR2) *Fig. 1,9	t _{WR(FIR2)}	$V_{SD} \le 0.5 \text{ V}, C_{L} = 15 \text{ pF},$ 4 Mbps, $t_{W} = 250 \text{ ns} \pm 10 \text{ ns}$ (Double pulse)	195		290	ns
RX wake up time *Fig. 1, 6	t _{Rwu}	$V_{SD} \le 0.5 \text{ V}, E_I = 17.0 \ \mu\text{W/cm}^2$		100	200	μs
Receiver latency time *Fig. 1, 7	t _L	$V_{SD} \le 0.5 \text{ V}, E_I = 17.0 \ \mu\text{W/cm}^2$		100	200	μs
Rise time *Fig. 1, 9	t _r	$V_{SD} \le 0.5 \text{ V}, C_L = 15 \text{ pF}$		10		ns
Fall time *Fig. 1, 9	t _f	$V_{SD} \le 0.5 \text{ V}, C_L = 15 \text{ pF}$	_	10		ns

Electrical-Optical Characteristics (continued)

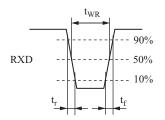
Note) Measurement circuit



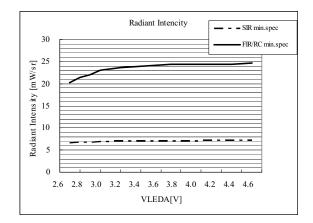
Electrical-Optical Characteristics (continued)

Note) Measurement circuit (continued)

*Fig. 9:

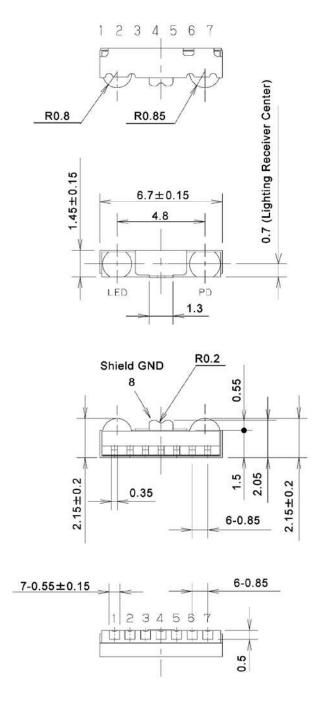


*Fig. 10:



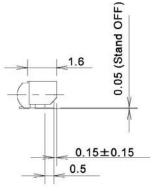
Panasonic

Package (Unit: mm)



• Pin name

1. V _{LEDA}	5. SD
2. V _{IO}	6. V _{CC}
3. TXD	7. GND
4. RXD	8. Shield GND



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